



MICRO NETWORKS

MN5210 Series

13 μ sec, 12-Bit
MILITARY A/D CONVERTERS

FEATURES

- 13 μ sec Maximum Conversion Time
- $\pm 1/2$ LSB Linearity and No Missing Codes Guaranteed Over Temperature
- Small 24-Pin DIP
- ± 1 LSB Zero Error
- ± 2 LSB Absolute Accuracy
- Low Power
- Full Mil Operation -55°C to +125°C
- MIL-H-38534 Screening Optional. MIL-STD-1772 Qualified Facility

DESCRIPTION

MN5210 Series devices are high-speed, 12-bit, successive approximation A/D converters in industry-standard, 24-pin dual-in-line packages. Conversion time is 13 μ sec max, and all specifications are met with a 1MHz clock. Functional laser trimming of our own nichrome thin-film resistor networks results in adjustment-free devices that are extremely accurate and highly stable. Zero error, for example, is guaranteed to be better than $\pm 0.025\%$ FSR (± 1 LSB) at +25°C and better than $\pm 0.05\%$ FSR (± 2 LSB) over the entire operating temperature range. All units are fully specified and 100% tested for linearity and accuracy at their operating temperature extremes as well as at room temperature.

These A/D converters are available in a number of input voltage ranges. For each range, the user has the option of specifying a model complete with internal reference or, for improved overall accuracy, a model which uses an external reference. In all cases, $\pm 1/2$ LSB linearity and 12-bit "no missing codes" are guaranteed over the entire operating temperature range.

All models of the MN5210 Series may be procured for operation over the full -55°C to +125°C military temperature range ("H" models) or the 0°C to +70°C commercial temperature range. For military/aerospace or harsh-environment commercial/industrial applications, "H/B CH" models are fully screened to MIL-H-38534 in Micro Networks MIL-STD-1772 qualified facility.

The MN5210 Series (13 μ sec conversion time) and MN5200 Series (50 μ sec conversion time) are the industry's most widely accepted 12-bit A/D's for military/aerospace applications. These devices are presently designed into more than 50 military/aerospace programs. Their small size, low power consumption and adjustment-free operation make them excellent selections for compact, highly reliable systems. New applications will be found wherever size, speed, power and temperature considerations are paramount.

MN5210



MICRO NETWORKS

324 Clark St., Worcester, MA 01606 (508) 852-5400

January 1992
Copyright © 1992
Micro Networks
All rights reserved

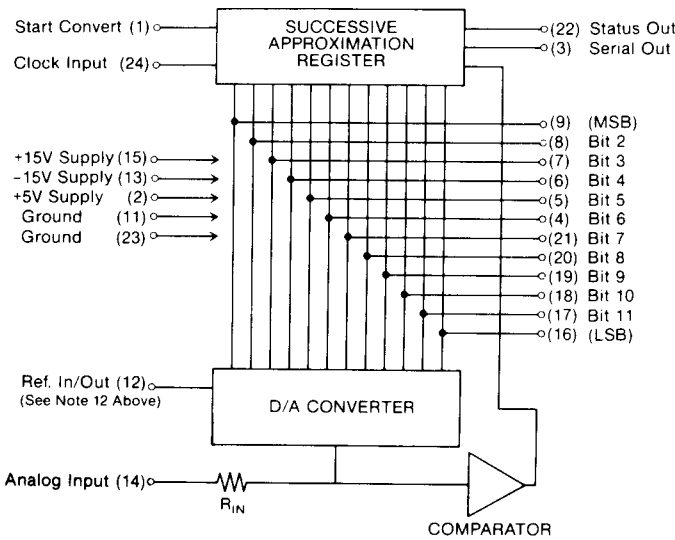
SPECIFICATION NOTES:

1. Consult factory for other available input voltage ranges.
2. Micro Networks tests and guarantees maximum linearity error at room temperature and at both the high and low extremes of the specified operating temperature range.
3. 1 LSB for a 12 bit converter corresponds to 0.024%FSR. See Note 4.
4. FSR stands for Full Scale Range and is equal to the peak to peak voltage of the selected input range. For the $\pm 10V$ input range, FSR is 20 volts, and 1 LSB is equal to 4.88 mV. For the 0 to +10V, 0 to -10V, and $\pm 5V$ ranges, FSR is 10 volts, and 1 LSB is equal to 2.44 mV.
5. See Absolute Accuracy section below for an explanation of how Micro Networks tests and specifies Full Scale Absolute Accuracy, Gain, and Zero Errors.
6. Conversion Time is defined as the width of the converter's STATUS (E.O.C.) pulse (see Timing Diagram). Micro Networks guarantees MN5210 Series converters will meet all specs with clock frequencies up to 1 MHz.

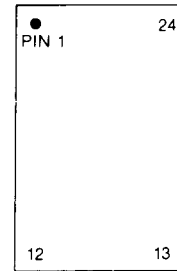
A 1 MHz clock gives a STATUS pulse that is 12 μ Sec wide. The 13 μ Sec spec reflects the fact that unless careful timing precautions are taken, it will usually take 13 clock periods to update digital output data.

7. Micro Networks tests and guarantees Power Supply Rejection over the $\pm 15V \pm 3\%$ range.
8. The clock may be asymmetrical with minimum positive or negative pulse width. See Note 6.
9. In order to reset the converter, START CONVERT must be brought low at least 25 nSec prior to a low to high clock transition. See Timing Diagram.
10. CSB = Complementary Straight Binary
COB = Complementary Offset Binary
Serial and parallel output data have the same coding. Serial data is in Non-Return to Zero (NRZ) format. See Output Coding and Timing Diagram.
11. One TTL load is defined as sinking 40 μ A with a logic "1" applied and sourcing 1.6 mA with a logic "0" applied.
12. MN5210, MN5211, MN5212, and MN5216 have an internal -6.3V reference. MN5213, MN5214, and MN5215 require an external -10.000V reference.

BLOCK DIAGRAM



PIN DESIGNATIONS



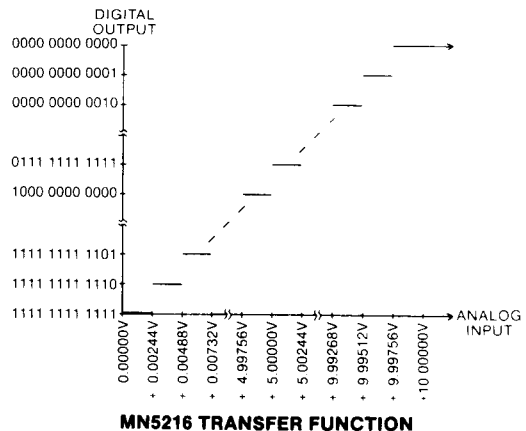
Pin 1 Start Convert	Pin 24 Clock Input
Pin 2 +5V Supply	Pin 23 Ground
Pin 3 Serial Output	Pin 22 Status (E.O.C.)
Pin 4 Bit 6	Pin 21 Bit 7
Pin 5 Bit 5	Pin 20 Bit 8
Pin 6 Bit 4	Pin 19 Bit 9
Pin 7 Bit 3	Pin 18 Bit 10
Pin 8 Bit 2	Pin 17 Bit 11
Pin 9 Bit 1 (MSB)	Pin 16 Bit 12 (LSB)
Pin 10 2.2 μ F to +15V	Pin 15 +15V Supply
Pin 11 Ground	Pin 14 Analog Input
Pin 12 Ref. Out (-6.3V) Ref. In (-10.0V)	Pin 13 -15V Supply

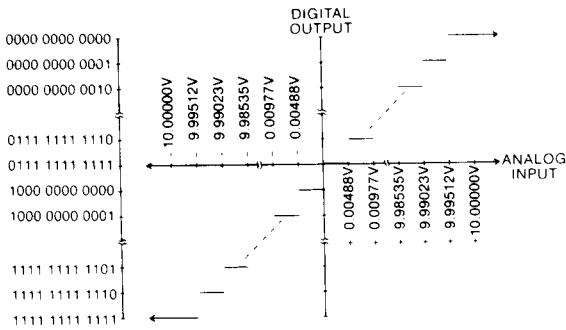
MN5210

ABSOLUTE ACCURACY ERROR

A given digital output code is valid for a band of analog input voltages that is ideally 1 LSB wide. This is demonstrated in the next column and on the following page where portions of the theoretical analog input/digital output transfer functions of the MN5216 (0 to +10V input range) and the MN5212 ($\pm 10V$ input range) are sketched.

Notice that, for the MN5216, any analog input between +0.00244 volts (1 LSB = 2.44 mV) and +0.00488 volts will give a digital output of 1111 1111 1110. If we assign this code to the nominal midrange of the analog input band for which it is valid, we can say that the 1111 1111 1110 digital code corresponds to analog inputs of +3.66 mV ± 1.22 mV which can be written as +3.66 mV $\pm 1/2$ LSB. The $\pm 1/2$ LSB is a quantization uncertainty unavoidable in A/D conversion. It is referred to as Inherent Quantization Error and its magnitude can be reduced only by going to higher resolution converters.





MN5212 TRANSFER FUNCTION

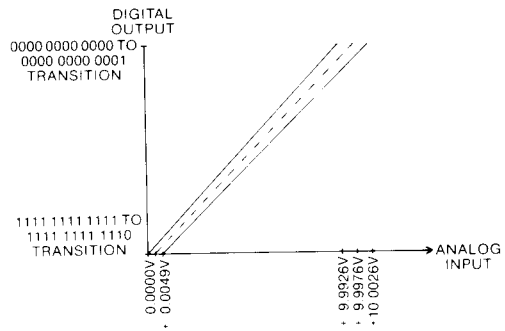
It is difficult and time consuming to measure the center of a quantization level (the +0.00366 volts in this example). The only points along an A/D converter's analog input/digital output transfer function that can quickly and accurately be detected and measured are the transition voltages, the voltages at which the digital outputs change from one code to the next. The *Absolute Accuracy Error* of a voltage input A/D converter is the difference between the actual, *unadjusted*, analog input voltage at which a *given* digital transition occurs and the analog input voltage at which that transition is ideally supposed to occur. This difference is usually expressed in LSB's or %FSR (see Note 4 above). Absolute Accuracy Error includes gain, offset, linearity, and noise errors, and when specified over temperature, encompasses the individual drifts of these errors.

For the MN5210 Series A/D converters, Micro Networks tests Absolute Accuracy Error at both endpoints of unipolar input ranges and at both endpoints and the midpoint of bipolar input ranges. These tests are performed at room temperature and at both the high and low extremes of the specified operating temperature range. The specifications appear in the table as the Full Scale Absolute Accuracy and Zero Errors.

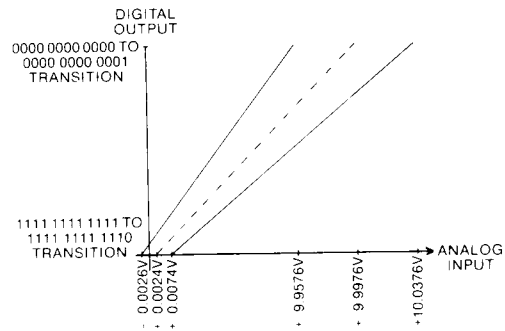
EXAMPLE MN5216: Return to the ideal analog input/digital output transfer function of the MN5216 sketched on page 3. Notice that the digital output data changes from 1111 1111 1111 to 1111 1111 1110 when the input voltage increases from 0V to +2.44 mV. It changes from 1111 1111 1110 back to 1111 1111 1111 as the input voltage is decreased from some more positive voltage to +2.44 mV. This voltage, +2.44 mV is the zero transition voltage. It is the voltage at which the LSB changes from a "1" to a "0" or vice versa while all other bits remain "1". The positive full scale LSB transition voltage, the voltage at which the LSB changes while the other bits remain "0", is ideally +9.9976V.

For the MN5216H (0 to +10V input range, -55°C to +125°C operation), Micro Networks tests linearity and the accuracy of the two transition voltages just discussed at -55°C, +25°C, and +125°C. We guarantee that the transfer function will be $\pm 1/2$ LSB linear at all temperatures and that the zero transition will be within $\pm 0.025\%$ FSR (± 2.5 mV) of its ideal value (+2.44 mV) at +25°C and within $\pm 0.05\%$ FSR (± 5 mV) of its ideal value at -55°C and at +125°C. This is our Zero Error specification. We guarantee that the positive full scale LSB transition voltage will be within $\pm 0.05\%$ FSR (± 5 mV) of its ideal value (+9.9976V) at +25°C and within $\pm 0.4\%$ FSR (± 40 mV) of its ideal value at -55°C and +125°C. This is our Full Scale Absolute Accuracy Error specification.

These Absolute Accuracy Error specifications are summarized in the two plots below. The ideal transfer function is now sketched as a broken line. We guarantee, for the MN5216H, that the actual transfer function will be $\pm 1/2$ LSB linear and that all the transition voltages will fall within the boundaries indicated by the solid lines at +25°C and at -55°C and +125°C.



MN5216 ABSOLUTE ACCURACY +25°C



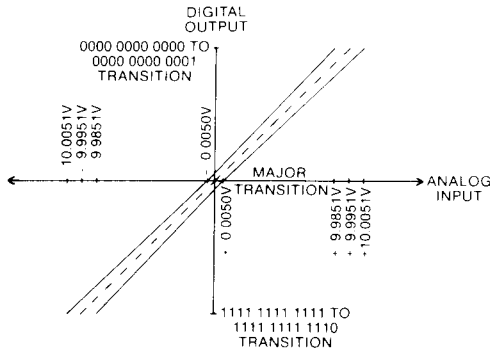
MN5216H ABSOLUTE ACCURACY -55°C AND +125°C

EXAMPLE MN5212: Return to the ideal analog input/digital output transfer function of the MN5212 sketched above. Notice that the digital output data changes from 1111 1111 1111 to 1111 1111 1110 when the input voltage increases from 0V to +2.44 mV. It changes from 1111 1111 1110 back to 1111 1111 1111 as the input voltage is decreased from some more positive voltage to -9.9951V. This voltage, -9.9951V, is the negative full scale LSB transition voltage. It is the voltage at which the LSB changes from a "1" to a "0" or vice versa while all other bits remain "1". The 1000 0000 0000 to 0111 1111 1111 transition (called the "major transition" because all the bits change) ideally occurs at the zero volt analog input. The positive full scale LSB transition voltage, the voltage at which the LSB changes while the other bits remain "0", is ideally +9.9951V.

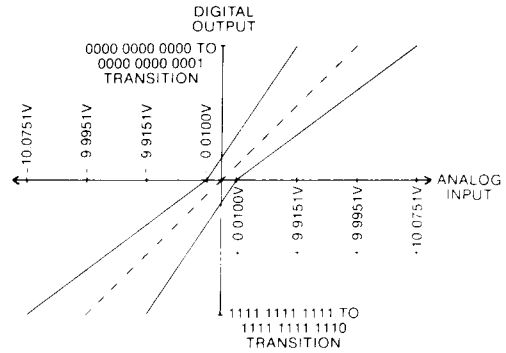
For the MN5212H (± 10 V input range, -55°C to +125°C operation), Micro Networks tests linearity and the accuracy of the three transition voltages just discussed at -55°C, +25°C, and +125°C. We guarantee that the transfer function will be $\pm 1/2$ LSB linear at all temperatures and that the positive and negative full scale LSB transition voltages will be within $\pm 0.05\%$ FSR (± 10 mV) of their ideal values (+9.9951V and -9.9951V) at +25°C and within $\pm 0.4\%$ FSR (± 80 mV) of their ideal values at -55°C and +125°C. This is our Full Scale

Absolute Accuracy Error specification. We also guarantee that the major transition voltage will be within $\pm 0.025\%$ FSR (± 5 mV) of its ideal value (zero volts) at $+25^\circ\text{C}$ and within $\pm 0.05\%$ FSR (± 10 mV) of its ideal value over the entire -55°C to $+125^\circ\text{C}$ operating temperature range. This is our Zero Error specification.

These Absolute Accuracy Error specifications are summarized in the two plots below. The ideal transfer function is now sketched as a broken line. We guarantee, for the MN5212H, that the actual transfer function will be $\pm 1/2$ LSB linear and that all the transition voltages will fall within the boundaries indicated by the solid lines at $+25^\circ\text{C}$ and at -55°C and $+125^\circ\text{C}$.



MN5212 ABSOLUTE ACCURACY $+25^\circ\text{C}$

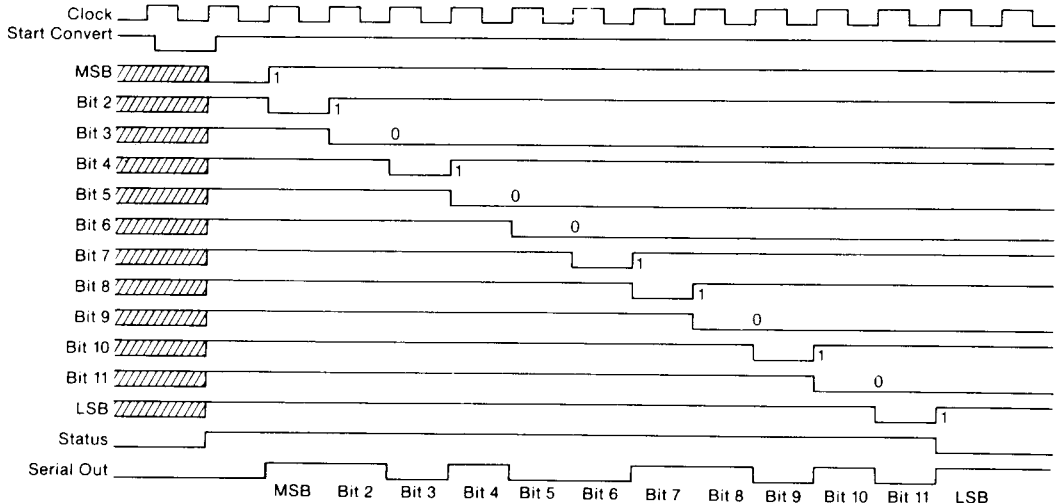


MN5212H ABSOLUTE ACCURACY -55°C AND $+125^\circ\text{C}$

Because Micro Networks tests and guarantees $\pm 1/2$ LSB linearity at all temperatures, the Absolute Accuracy of any transition voltage can be interpolated from the Full Scale Absolute Accuracy and Zero Error specifications. Example: at $+25^\circ\text{C}$, the 1000 0000 0000 to 0111 1111 1111 transition of its MN5216 will occur within $\pm 0.0375\%$ FSR (± 3.75 mV) of its ideal value ($+5.000\text{V}$). For temperatures intermediate to $+25^\circ\text{C}$ and -55°C or $+125^\circ\text{C}$, maximum Full Scale Absolute Accuracy and Zero Errors can also be interpolated. At $+75^\circ\text{C}$, for example, Full Scale Absolute Accuracy Error will be $\pm 0.225\%$ FSR.

We have not specified Unipolar and Bipolar Offset Errors for the MN5210 Series. We feel that Offset is a confusing

TIMING DIAGRAM



TIMING DIAGRAM NOTES:

- Operation shown is for the digital word 1101 0011 0101 which corresponds to 1.7432V on the 0 to +10V input range (MN5216). See Output Coding.
- Conversion time is defined as the width of the STATUS (E.O.C.) pulse.
- The converter is reset (MSB = "0", all other bits = "1", STATUS = "1") by holding the START CONVERT low during a low to high clock transition. The START CONVERT must be low for a minimum of 25 nSec prior to the clock transition. Holding the START low will hold the converter in the reset state. Actual conversion will begin on the next rising clock edge after the START has returned high.
- The delay between the resetting clock edge and STATUS actually rising to a "1" is 120 nSec maximum.
- The START CONVERT may be brought low at any time during a conversion to reset and begin converting again.
- Both serial and parallel data bits become valid on the same rising clock edges. Serial data is valid on subsequent falling clock edges, and these edges can be used to clock serial data into receiving registers.
- Output data will be valid 30 nSec (maximum) after the STATUS (E.O.C.) output has returned low. Parallel output data will remain valid and the STATUS output low until another conversion is initiated.
- For continuous conversion, connect the STATUS output (Pin 22) to the START CONVERT input (Pin 1). See section on Continuous Conversion.
- When the converter is initially "powered up", it may come on at any point in the conversion cycle.

specification and choose not to use it. Offset Errors for the MN5210 Series will always be equivalent to either our Full Scale Absolute Accuracy or Zero Errors and we prefer these specifications because of their simplicity. Be sure you clearly understand each manufacturer's converter specification definitions before you compare converters solely on a data sheet basis.

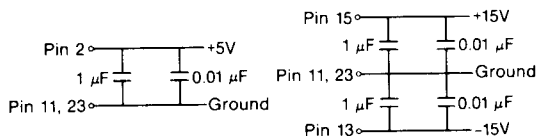
GAIN ERROR—Gain Error is the difference between the ideal and the measured values of a converter's Full Scale Range (minus 2 LSB); it is a measure of the slope of the converter's transfer function. Gain Error is not a type of Absolute Accuracy Error, but it can be calculated using two Absolute Accuracy Error measurements. It is equivalent to the Absolute Accuracy Error measured for the 0000 0000 0000 to 0000 0000 0001 transition minus that measured for the 1111 1111 1111 to 1111 1111 1110 transition.

See the Converter Tutorial Section of the Micro Networks' Applications Manual and Product Guide for a complete discussion of converter specifications.

APPLICATIONS INFORMATION

LAYOUT CONSIDERATIONS—Proper attention to layout and decoupling is necessary to obtain specified accuracies from the MN5210 Series converters. A 2.2 μ F (25V) non-polarized capacitor must be connected between Pin 10 and +15V. The units' two GROUND pins (Pins 11 and 23) are not connected internally. They should be tied together as close to the package as possible and connected to system analog ground, preferably through a large ground plane underneath the package. If the grounds cannot be tied together and must be run separately, a non-polarized 0.01 μ F bypass capacitor should be connected between Pins 11 and 23 as close to the unit as possible and wide conductor runs employed.

Power supplies should be decoupled with tantalum or electrolytic capacitors located close to the converters. For optimum performance and noise rejection, 1 μ F capacitors paralleled with 0.01 μ F ceramic capacitors should be used as shown in the diagrams below.



POWER SUPPLY DECOUPLING

DESCRIPTION OF OPERATION—The Successive Approximation Register (SAR) is a set of flip flops (and control logic) whose outputs act as both the direct (parallel) data outputs of the Analog to Digital Converter (A/D) and the digital drive for the A/D's internal Digital to Analog Converter (D/A). See Block Diagram. Holding the A/D's START CONVERT (Pin 1) low during a clock low to high transition resets the SAR. In this state, the output of the MSB flip flop is set to logic "0", the outputs of the other bit flip flops are set to logic "1", and the STATUS output (Pin 22) is set to logic "1" (see Timing Diagram). The START CONVERT must now be brought high again for the conversion to continue. If the START is not brought high, the converter will remain in the reset state.

The D/A internal to the A/D continuously converts the A/D's digital output back to an analog signal which the comparator continuously compares to the analog input signal. The comparator output ("1" or "0") informs the SAR whether the present digital output (0111 1111 1111 in the reset state) is "greater than" or "less than" the analog input. Depending upon which is greater, on the first rising clock edge after the START has returned high, the SAR will set the MSB to its final state ("1" or "0") and bring bit 2 down to a "0". The digital output is now X011 1111 1111. The D/A converts this to an analog value, and the comparator determines whether this value is greater or less than the analog input. On the next rising clock edge, the SAR reads the comparator feedback, sets bit 2 to its final value, and brings bit 3 down to a logic "0". The digital output is now XX01 1111 1111. This successive approximation procedure continues until all the output bits are set. The rising clock edge that sets the LSB (bit 12) also drops the STATUS OUTPUT to a "0" signaling that the conversion is complete. Output data is now valid and will remain so until another conversion is started. The clock does not have to be turned off.

CONTINUOUS CONVERTING — The MN5210 Series A/D converters can be made to continuously convert by tying the STATUS output (Pin 22) to the START CONVERT input (Pin 1). In this configuration, STATUS (START CONVERT) will go low at the end of a conversion (see Timing Diagram) and the next rising clock edge will reset the converter bringing STATUS (START CONVERT) high again. The MSB will be set on the next rising clock edge. The result is that the STATUS will go low for approximately one clock period following each conversion. Please read the section describing the STATUS output. See below for continuous conversions while short cycling.

DIGITAL OUTPUT CODING

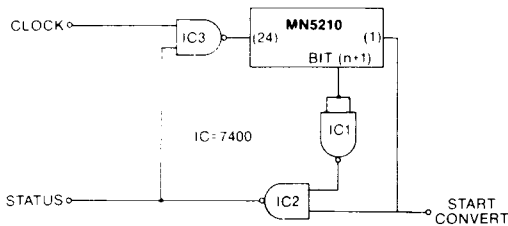
ANALOG INPUT				DIGITAL OUTPUT	
MN5210, 5213	MN5211, 5214	MN5212, 5215	MN5216	MSB	LSB
0.0000V	+5.0000V	+10.0000V	+10.0000V	0000	0000 0000
- 0.0024V	+4.9976V	+ 9.9951V	+ 9.9976V	0000	0000 0000*
- 4.9976V	+0.0024V	+ 0.0049V	+ 5.0024V	0111	1111 1110*
- 5.0000V	0.0000V	0.0000V	+ 5.0000V	0000	0000 0000*
- 5.0024V	-0.0024V	- 0.0049V	+ 4.9976V	1000	0000 0000*
- 9.9976V	-4.9976V	- 9.9951V	+ 0.0024V	1111	1111 1110*
-10.0000V	- 5.0000V	-10.0000V	0.0000V	1111	1111 1111

* Voltages given are the theoretical values for the transitions indicated. Ideally, with the converter continuously converting, the output bits indicated as 0 will change from "1" to "0" or vice versa as the input voltage passes through the level indicated. See the section on Absolute Accuracy Error for an explanation of Output Transition Voltages.

EXAMPLE: For an MN5212/15 (\pm 10V analog input range) the transition from

digital output 0000 0000 0000 to 0000 0000 0001 (or vice versa) will ideally occur at an input voltage of +9.9951 volts. Subsequently, any input voltage more positive than +9.9951 volts will give a digital output of all "0"s. The transition from digital output 1000 0000 0000 to 0111 1111 1111 will ideally occur at an input of zero volts, and the 1111 1111 1111 to 1111 1111 1110 transition should occur at -9.9951 volts. An input more negative than -9.9951 volts will give all "1"s.

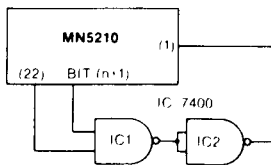
SHORT CYCLING—For applications requiring less than 12 bits resolution, the MN5210 Series A/D's can be truncated or short cycled to the desired number of bits with a proportionate decrease in conversion time. The following circuit may be used to truncate at n bits.



SHORT CYCLING SINGLE CONVERSIONS

Assuming a conversion is already in progress, bit (n+1) will go low as bit n is being set (see Timing Diagram). Since the START CONVERT signal is high at this time, STATUS (the output of IC2) will go low gating off the clock at IC3 ending the conversion. To begin a new conversion, START CONVERT is brought low driving STATUS high and gating on the clock. The first rising clock edge the converter sees with START CONVERT low will reset the converter bringing bit (n+1) high again. Now STATUS will remain high as START CONVERT is brought back high allowing the conversion to continue. Therefore, in this configuration, STATUS and START CONVERT function normally, i.e., the same as STATUS and START CONVERT for a converter not being short cycled.

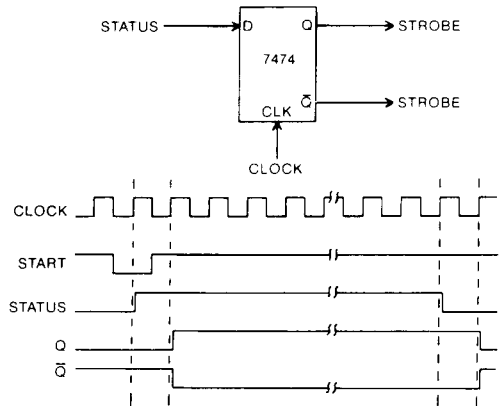
SHORT CYCLING AND CONTINUOUS CONVERTING—A previous section described how continuous converting for 12 bits could be accomplished by simply tying the STATUS output back to the START CONVERT input. To continuously convert at n bits, one simply has to tie the bit (n+1) output back to the START CONVERT input. The bit (n+1) output acts like a STATUS when one short cycles at n bits. It goes high when the converter is reset, remains a "1" during the conversion, and drops to a "0" as bit n is being set. Since it is possible for the converter to come on in any state at power-on, a lock-up condition may occur if bit (n+1) comes on as a "1" and the conversion process comes on at bit (n+2). This situation can be avoided by making the START CONVERT input the AND function of bit (n+1) and the STATUS output.



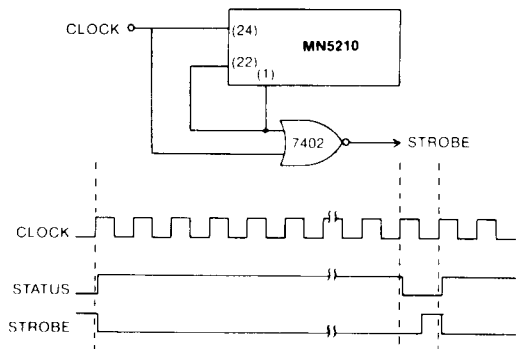
SHORT CYCLING CONTINUOUS CONVERTING

If one is already using the circuit described in the section labeled SHORT CYCLING, one can short cycle and continuously convert by making the START CONVERT input the AND function of STATUS (IC2) and STATUS (pin 7) outputs.

STATUS OUTPUT—The STATUS or END OF CONVERSION (E.O.C.) output will be set to a logic "1" when the converter is reset; will remain high during conversion, and will drop to a logic "0" when conversion is complete. Due to propagation delays, the least significant bit (LSB) of a given conversion may not be valid until a maximum of 30 nSec after STATUS has returned low. Therefore, an adequate delay must be provided if STATUS is to be used to strobe latches to hold output data. Simple gate delays can be employed or the STATUS can be made the input of a D flip flop whose clock input is the same as the converter clock (see sketch). In this situation, the Q output will change one clock period after STATUS changes.



If continuously converting the STATUS (E.O.C.) output can be NORed with the converter clock, as shown below, to produce a positive strobe pulse 1/2 period wide, 1/2 period after the STATUS output has gone low. The rising edge of this pulse can be used to latch data after each conversion.



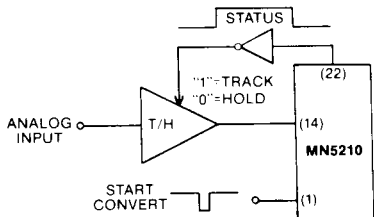
USING A TRACK AND HOLD AMP WITH MN5210 SERIES A/D'S

The error that results when trying to convert moving analog signals with a successive approximation A/D can be as great as the amount the analog signal changes during a single A/D conversion time. If this error is unacceptable, a Track and Hold (T/H) or Sample and Hold (S/H) amplifier can be placed between the analog signal source and the A/D converter. A careful error analysis will be necessary to determine if the T/H is actually reducing and not increasing overall error. T/H parameters such as aperture uncertainty, gain accuracy, pedestal error and droop rate will have to be contended with (see the tutorial section of the Micro Networks'

MN5210

Applications Manual and Product Guide for a complete discussion of T/H parameters).

Normally, the T/H can be controlled directly by the A/D's STATUS output. Typical connections are shown below for Micro Networks' MN343 (10 μ Sec acquisition time to $\pm 0.01\%$) and MN346 (1.6 μ Sec acquisition time to $\pm 0.01\%$) Track and Hold Amplifiers. The STATUS output changes from a "0" to a "1" when the converter is reset. This drives the T/H from the track to the hold mode. At the end of conversion, STATUS returns to a "0" restoring the T/H to the track mode.



MN343

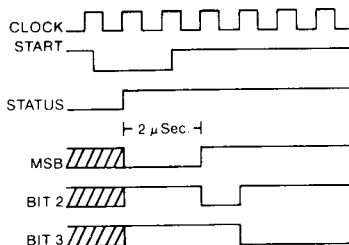
10 μ Sec
60 nSec
3 mV
0.1 mV/mSec
1.5 μ Sec

Acquisition Time
Aperture Delay
Pedestal Error
Droop Rate
Track to Hold Settling

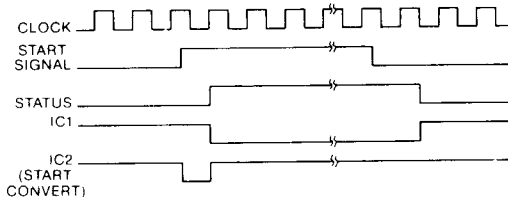
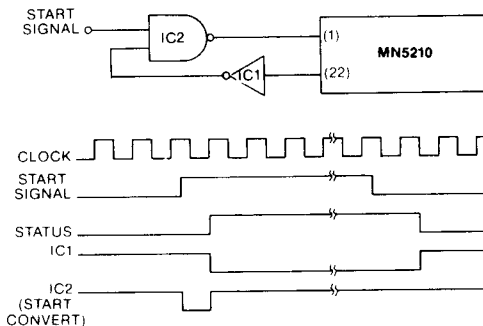
MN346

1.6 μ Sec
30 nSec
2 mV
0.1 mV/mSec
150 nSec

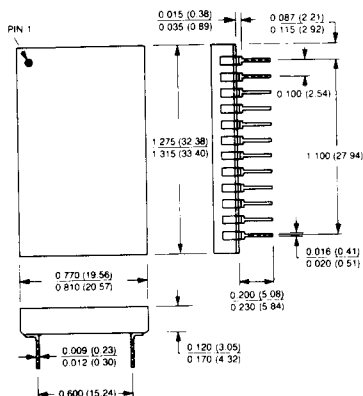
Recall that if the START CONVERT pulse is brought high immediately after the converter has been reset, the MSB will be finalized one clock period later (see Timing Diagram). Care should be taken to ensure aperture delay time and track-to-hold settling time do not contribute errors. If necessary, the width of the START CONVERT pulse can be increased to allow more time between the T/H being commanded into the hold mode (STATUS = "1") and the MSB being set. Recall that output bits do not begin to get set until after the START CONVERT has returned high. The example below shows a 2 μ Sec delay to allow for track to hold settling. Clock frequency = 1 MHz; 1 period = 1 μ Sec.



TRIGGERING WITH A POSITIVE EDGE—If it is inconvenient to generate a negative going START CONVERT PULSE of the proper width, MN5210 Series A/D's can be made to start converting on a positive going edge by employing the circuit shown below. Assuming the previous conversion is done and the Start Signal is low, the STATUS output will be low, the output of IC1 will be high, and the output of IC2 will be high. A rising edge as a Start Signal will drive the output of IC2 low. The converter will reset on the next rising clock edge. Resetting brings the STATUS high; IC1 goes low; the start Signal is still high so the output of IC2 goes high allowing the conversion to continue immediately. The Start Signal has only to be brought back down before the conversion is completed.



PACKAGING

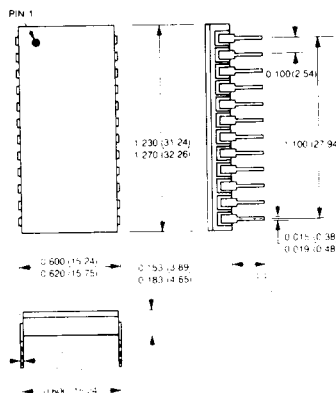


PACKAGE A

24-PIN DIP

Dimensions in Inches
(millimeters)

Note: MN5210 and MN5213
utilize package A.
MN5211, MN5212, MN5214,
MN5215 and MN5216 utilize
package B



PACKAGE B